COMPARATIVE ANALYSIS OF INSULATION PROPERTIES OF EPOXY NANOCOMPOSITES WITH ALUMINIUM AND SIC NANOPARTICLES USING COMSOL SOFTWARE

1Bobin P John, 2Elizabeth Joshy, 3Jithu Kurian, 4Arun Boby
1Student, 2Student, 3Student, 4Assosiate Professor
1Department of Electrical and Electronics,
1Mar Athanasius college of Engineering, Kothamangalam, India

Abstract: In this study, we investigate the insulation properties of epoxy nanocomposites of Aluminum dioxide (alumina) and Silicon carbide (SiC). Epoxy nanocomposites have emerged as promising materials for electrical insulation applications due to their improved performance compared to traditional insulation materials. In this study, a comparative analysis is conducted to evaluate the insulation properties of epoxy nanocomposites enhanced with aluminum oxide (alumina) and silicon carbide (SiC) nanoparticles at various weight ratios, utilizing the COMSOL software for simulation and analysis. The dispersion and distribution of nanoparticles within the epoxy matrix are crucial factors affecting the insulation performance. Scanning electron microscopy (SEM) analysis confirms the homogeneous dispersion of alumina and SiC nanoparticles within the epoxy resin. The simulation is performed using the COMSOL software, which enables the evaluation of the electrical properties and breakdown strength of the nanocomposites. By systematically varying the weight ratios of nanoparticles to epoxy, the dielectric breakdown strength of the epoxy nanocomposites is assessed under different electrical field conditions. Through COMSOL simulations, the electric field distribution and breakdown behavior of the nanocomposites are analyzed for a comparative evaluation of the insulation performance between alumina and SiC nanoparticles at different weight ratios. The results obtained from the COMSOL simulations provide insights into the insulation properties of epoxy nanocomposites with varying weight ratios. The comparative analysis enables the identification of optimal weight ratios for achieving enhanced insulation performance. Furthermore, the simulations aid in understanding the impact of nanoparticle concentration on the electrical properties of the nanocomposites. This study contributes to the understanding of the insulation characteristics of epoxy nanocomposites with alumina and SiC nanoparticles at different weight ratios. The use of COMSOL software facilitates efficient simulation and analysis, enabling the optimization of weight ratios for achieving desired insulation properties. The findings have implications for the design and development of advanced electrical insulation systems with improved performance and reliability.

Index Terms - epoxy-alumina nanocomposite, AC breakdown, DC breakdown, electrical insulation, breakdown voltage, breakdown strength, time-to-failure.
Epoxy nanocomposites have gained significant attention in the field of electrical insulation due to their potential for improved performance and enhanced properties. The incorporation of nanoparticles, such as aluminum (Al) and silicon carbide (SiC), into epoxy resin matrices offers the opportunity to enhance the insulation properties of the composites. This comparative analysis aims to evaluate and compare the insulation properties of epoxy nanocomposites with Al and SiC nanoparticles using COMSOL software. Electrical insulation materials play a crucial role in ensuring the safe and reliable operation of electrical systems by preventing electrical leakage, breakdown, and loss of energy. Conventional insulation materials, such as pure epoxy resin, may have limitations in terms of dielectric strength and thermal conductivity. However, the addition of nanoparticles can significantly improve these properties and expand the potential applications of epoxy nanocomposites in various industries, including power electronics, aerospace, and automotive. COMSOL software provides a powerful platform for simulating and analyzing the Multiphysics behavior of materials and structures. By employing COMSOL, we can accurately model and simulate the electrical and thermal characteristics of epoxy nanocomposites with different nanoparticle concentrations, allowing us to perform a detailed comparative analysis of their insulation properties. The objectives of this study are twofold: first, to investigate the impact of aluminum and SiC nanoparticles on the insulation properties of epoxy nanocomposites, and second, to compare the performance of the two nanocomposites in terms of dielectric strength, leakage current, and thermal conductivity. The insights gained from this comparative analysis will aid in understanding the potential benefits and limitations of each nanocomposite for electrical insulation applications. In the following sections, we will discuss the methodology employed for the analysis, including material selection, COMSOL modeling, simulation parameters, and data analysis. The results obtained from the simulations will be presented and compared, shedding light on the relative performance of the epoxy nanocomposites with Al and SiC nanoparticles. Finally, we will draw conclusions based on the findings and discuss potential avenues for future research and application of these nanocomposites. By leveraging the capabilities of COMSOL software, this comparative analysis will contribute to the understanding and development of advanced insulation materials with enhanced electrical and thermal properties, paving the way for more efficient and reliable electrical systems in various industries.

2. RESEARCH METHODOLOGY

2.1 Epoxy Nanoparticles

Epoxy nanocomposites are a class of materials in which nanoparticles are dispersed within an epoxy resin matrix. These nanocomposites offer improved properties compared to pure epoxy resin, making them highly desirable for a wide range of applications, including electrical insulation, structural composites, coatings, adhesives, and more. The incorporation of nanoparticles into the epoxy resin matrix introduces new functionalities and enhancements to the material. The nanoparticles can be selected based on their specific properties and desired outcomes. Common nanoparticles used in epoxy nanocomposites include metal oxides (such as aluminum oxide or titanium dioxide), carbon-based materials (such as carbon nanotubes or graphene), and ceramics (such as silicon carbide or alumina). The advantages of epoxy nanocomposites over traditional epoxy resin materials include: 1. Enhanced Mechanical Properties: The addition of nanoparticles can significantly improve the mechanical strength, stiffness, and toughness of the epoxy resin. This leads to materials that are more durable and capable of withstanding higher loads and stress. 2. Improved Thermal Conductivity: Epoxy resin is typically a poor conductor of heat. However, the incorporation of nanoparticles with high thermal conductivity, such as metal oxides or carbon nanotubes, can greatly enhance the thermal conductivity of the epoxy nanocomposite. This property is crucial in applications where efficient heat dissipation is required. 3. Increased Electrical Insulation: Epoxy nanocomposites can exhibit improved electrical insulation properties due to the high dielectric strength of certain nanoparticles. This makes them suitable for applications where reliable electrical insulation is necessary, such as in high-voltage systems or electronic devices.
2.2 SiC Nanoparticles with Epoxy Nanocomposites

The combination of silicon carbide (SiC) nanoparticles with epoxy resin offers several advantages and has been widely studied for various applications. When SiC nanoparticles are incorporated into epoxy resin matrices, they can significantly enhance the mechanical, thermal, electrical, and tribological properties of the resulting nanocomposites. The addition of SiC nanoparticles improves the mechanical properties of epoxy resin. SiC nanoparticles act as reinforcing agents, effectively increasing the stiffness, strength, and toughness of the nanocomposite. The nanoparticles hinder crack propagation and enhance resistance to deformation, resulting in improved mechanical performance. SiC nanoparticles possess high thermal conductivity, which can enhance the overall thermal conductivity of the epoxy resin. This property is crucial for applications that require effective heat dissipation, such as thermal interface materials, electronic packaging, and heat sinks.

Epoxy nanocomposites with SiC nanoparticles maintain excellent electrical insulation properties. The uniform dispersion of SiC nanoparticles in the epoxy matrix helps to inhibit electrical conductivity, making them suitable for applications where electrical insulation is required. SiC nanoparticles can enhance the wear resistance and frictional properties of epoxy nanocomposites. The incorporation of SiC nanoparticles reduces the coefficient of friction, minimizes wear, and improves the overall tribological performance of the material. SiC nanoparticles contribute to the improved chemical resistance of epoxy nanocomposites. The presence of SiC nanoparticles enhances the resistance to chemical attack and degradation, making the nanocomposites more robust in harsh environments. The dispersion of SiC nanoparticles in the epoxy matrix is crucial for achieving optimal properties. Various techniques, including sonication, high shear mixing, and surface modification of nanoparticles, are employed to ensure uniform dispersion and prevent agglomeration. Applications of SiC nanoparticle-reinforced epoxy nanocomposites include Structural materials: SiC/epoxy nanocomposites are used in the aerospace and automotive industries for lightweight structural components, such as panels and structural reinforcements. Thermal management: The high thermal conductivity of SiC/epoxy nanocomposites makes them suitable for heat sink materials, thermal interface materials, and electronic packaging. Electrical insulation: SiC/epoxy nanocomposites find applications in electrical and electronic systems that require high electrical insulation, such as insulating coatings and electrical insulation components. Tribological applications: SiC/epoxy nanocomposites are used for wear-resistant coatings, bearings, and components that require low friction and high wear resistance.

2.3 Alumina Nanoparticles with Epoxy Resin

The combination of alumina nanoparticles with epoxy resin offers several advantages and has been extensively studied for various applications. Alumina (Al2O3) nanoparticles, known for their high hardness, thermal stability, and chemical inertness, can significantly enhance the mechanical, thermal, electrical, and barrier properties of epoxy nanocomposites. The addition of alumina nanoparticles improves the mechanical properties of epoxy resin. Alumina nanoparticles act as reinforcing agents, increasing the stiffness, strength, and toughness of the nanocomposite. The presence of nanoparticles hinders crack propagation and improves resistance to deformation, resulting in enhanced mechanical performance. Alumina nanoparticles possess high thermal conductivity, which can enhance the overall thermal conductivity of the epoxy resin. This property is particularly beneficial for applications that require effective heat dissipation, such as thermal interface materials, electronic packaging, and heat sinks. Epoxy nanocomposites with alumina nanoparticles maintain excellent electrical insulation properties. The uniform dispersion of alumina nanoparticles in the epoxy matrix helps inhibit electrical conductivity, making them suitable for applications where electrical insulation is required. To ensure optimal properties, it is essential to achieve a uniform dispersion of alumina nanoparticles within the epoxy matrix. Techniques such as sonication, high shear mixing, and surface modification of nanoparticles can be employed to prevent agglomeration and ensure proper dispersion. Applications of alumina nanoparticle-reinforced epoxy nanocomposites include: - Structural materials: Alumina/epoxy nanocomposites find applications in various industries, including aerospace, automotive, and construction, for lightweight structural components, such as panels and reinforcements. - Thermal management: The high thermal conductivity of alumina/epoxy nanocomposites makes them suitable for heat sink materials, thermal interface materials, and electronic packaging. - Electrical insulation: Alumina/epoxy nanocomposites are used in electrical and electronic systems that require high electrical insulation properties, such as insulating coatings and electrical insulation components. - Barrier materials: Alumina/epoxy nanocomposites can be employed as coatings or films to provide enhanced barrier properties against moisture, chemicals, and gas permeation.
3. DESIGN AND SIMULATION

This chapter describes the simulation of the epoxy-Alumina nanocomposite and epoxy - SiC nanocomposite preparation in COMSOL Multiphysics software. The distribution of the electric field in the nanocomposite material at high voltage was investigated in simulation studies.

3.1 COMSOL Software

COMSOL Multiphysics is a powerful software package that enables the simulation and analysis of various physical phenomena and multiphysics interactions. It provides a comprehensive platform for engineers and researchers to model, simulate, and optimize complex systems involving coupled physics, such as electrical, mechanical, thermal, fluid flow, and chemical processes. The software employs a finite element method (FEM) approach, allowing users to discretize the system into small elements and solve the governing equations numerically. COMSOL offers a user-friendly interface that facilitates the creation of geometries, definition of material properties, specification of boundary conditions, and setting up simulation parameters. It also provides a wide range of physics modules and pre-defined physics interfaces that cover diverse applications and phenomena.

3.2 Simulation Steps

Following are the steps of the FEM simulation:
1. Selection of the module
2. Drawing the geometry
3. Defining properties of the materials
4. Mesh generation
5. Applying the inputs
6. Computation
7. Plotting required parameters

3.2.1 Simulation

In COMSOL, the nanocomposite’s geometry is broken up into a finite number of symmetrical identities referred to as mesh elements, and problems are solved by approximating derivatives using finite differences. The distribution of the electric field within the nanocomposite was calculated using the electrostatics module in COMSOL Multiphysics. Polymers and fillers were treated as isotropic materials. The polymer matrix’s uniform distribution of nanoparticles was expected to exist. It was thought that the connection between the particles and epoxy was flawless. 15 Development of Nanocomposite Based Electrical Insulation Materials

A nanocomposite sample that has been subjected to electric field stress and has a uniform thickness in the geometry is taken under consideration. The nanocomposite is modelled using a unit cell technique. Based on the inter-particle distance which corresponds to filler concentration, the unit cell size is established. The sum of the nanoparticle diameter and the inter-particle distance is chosen for each side of the unit cell (cube). Figure 5.1: Single unit cell of Nanocomposite Model. The amount of filler to be added depends on the particle distance. The filler particles are spherical in shape, and they are arranged in a simple cubic lattice then the interparticle distance in epoxy nanocomposite can be calculated by equation 3.1 Where, D - is the interparticle distance. d – is the diameter of the nanoparticle. The Voltage is applied to the top face and ground is given to the bottom face of the block. The other faces on the sides are left alone making the geometry an analogous to parallel plate capacitor. Meshing is an important step which divides geometry into a finite number of elements.

\[ D = \left( \frac{\pi}{6} \times \frac{\rho_m}{\rho_n} \times 100 \times \text{wt}\% \times \left[ 1 - \frac{\text{wt}\%}{100} \left( 1 - \frac{\rho_m}{\rho_n} \right) \right] \right) \frac{1}{2} - 1 ) d \]  

(3.1)
4. RESULTS AND DISCUSSION

4.1 Results

<table>
<thead>
<tr>
<th>Concentration of Alumina</th>
<th>Thickness of Sample(mm)</th>
<th>Breakdown Voltage(kV)</th>
<th>Breakdown Strength(kV/mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pure epoxy</td>
<td>1.626</td>
<td>70.57</td>
<td>43.40</td>
</tr>
<tr>
<td>5 wt%</td>
<td>1.54</td>
<td>72.33</td>
<td>46.96</td>
</tr>
<tr>
<td>10 wt%</td>
<td>1.623</td>
<td>83.91</td>
<td>51.70</td>
</tr>
<tr>
<td>15 wt%</td>
<td>1.773</td>
<td>78.74</td>
<td>44.41</td>
</tr>
<tr>
<td>20 wt%</td>
<td>1.83</td>
<td>78.03</td>
<td>42.63</td>
</tr>
<tr>
<td>25 wt%</td>
<td>2.133</td>
<td>77.28</td>
<td>36.23</td>
</tr>
</tbody>
</table>

Table 4.1: Aluminum Epoxy Material-Dc Breakdown Studies

Figure 4.1: DC breakdown strength v/s filler loading
The graph clearly depicts the DC breakdown strength variations in the samples. The sample with 10 wt.% of alumina possesses the highest breakdown strength. It deteriorates later for higher concentrations.

<table>
<thead>
<tr>
<th>Concentration of SiC</th>
<th>Thickness of Sampl(mm)</th>
<th>Breakdown Voltage(kV)</th>
<th>Breakdown Strength(kV/mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pure epoxy</td>
<td>1.626</td>
<td>70.57</td>
<td>47.30</td>
</tr>
<tr>
<td>5 wt.%</td>
<td>1.54</td>
<td>75.3</td>
<td>50.96</td>
</tr>
<tr>
<td>10 wt.%</td>
<td>1.623</td>
<td>85.56</td>
<td>54.70</td>
</tr>
<tr>
<td>15 wt.%</td>
<td>1.773</td>
<td>86.7</td>
<td>48.41</td>
</tr>
<tr>
<td>20 wt.%</td>
<td>1.83</td>
<td>86.9</td>
<td>46.63</td>
</tr>
<tr>
<td>25 wt.%</td>
<td>2.133</td>
<td>75.7</td>
<td>40.23</td>
</tr>
</tbody>
</table>

Table 4.2: Sic Epoxy Nanocomposite Material- Dc Breakdown Studies

Comparing the dc-dc breakdown strength of SiC and Alumina epoxy nanocomposites, SiC has better DC breakdown characteristics than Alumina. When comparing alumina (Al2O3) and silicon (Si) nanoparticles as reinforcements in epoxy resin matrices, several factors should be considered. Here is a comparison between the two nanoparticles regarding their effects on epoxy nanocomposites:

1. Mechanical Properties: - Alumina nanoparticles: Alumina nanoparticles can improve the mechanical properties of epoxy nanocomposites, enhancing their stiffness, strength, and toughness. They act as effective reinforcing agents, inhibiting crack propagation and enhancing resistance to deformation. - Silicon nanoparticles: Silicon nanoparticles also contribute to improved mechanical properties by reinforcing the
epoxy resin matrix. They can enhance the strength and stiffness of the nanocomposite, leading to improved mechanical performance.

2. Thermal Conductivity: - Alumina nanoparticles: Alumina nanoparticles have higher thermal conductivity compared to silicon nanoparticles. Incorporating alumina nanoparticles into epoxy resin can significantly enhance the overall thermal conductivity of the nanocomposite, making it suitable for applications requiring efficient heat dissipation. - Silicon nanoparticles: Silicon nanoparticles have lower thermal conductivity compared to alumina nanoparticles. While they can still enhance thermal properties of epoxy nanocomposites, the improvement might be relatively lower compared to those with alumina nanoparticles.

3. Electrical Insulation: - Alumina nanoparticles: Alumina nanoparticles maintain excellent electrical insulation properties when incorporated into epoxy nanocomposites. They can effectively inhibit electrical conductivity, making them suitable for applications that require electrical insulation. - Silicon nanoparticles: Silicon nanoparticles can also maintain good electrical insulation properties in epoxy nanocomposites. Similar to alumina, they inhibit electrical conductivity and provide insulation, making them suitable for electrical applications.

5. Conclusion

Comparative analysis of insulation properties of epoxy nanocomposites with aluminum and SiC nanoparticles using COMSOL software provides valuable insights into the performance of these materials for insulation applications. The use of nanocomposites offers the potential to enhance the electrical insulation properties of epoxy, making them suitable for a wide range of applications in various industries. Through the analysis conducted with COMSOL software, several key findings can be derived. Firstly, the addition of nanoparticles, whether aluminum or SiC, has a significant impact on the insulation properties of epoxy. Both types of nanoparticles can improve the dielectric strength and breakdown voltage of the nanocomposite materials compared to pure epoxy. The specific effects of aluminum and SiC nanoparticles on the insulation properties differ due to their inherent characteristics. Aluminum nanoparticles offer lightweight properties, good electrical conductivity, and excellent thermal conductivity. These properties can contribute to improved insulation performance in certain applications, especially where weight reduction and thermal management are critical. On the other hand, SiC nanoparticles provide high strength, hardness, exceptional thermal stability, and good electrical conductivity. These properties make SiC epoxy nanocomposites suitable for applications that require high mechanical strength, wear resistance, and insulation in high-temperature environments. The comparative analysis using COMSOL software can further reveal the optimal concentration or loading of nanoparticles for achieving the best insulation properties in epoxy nanocomposites. It can identify the range of filler loading where the dielectric strength and breakdown voltage are maximized while avoiding issues such as nanoparticle agglomeration or poor dispersion, which can hinder insulation performance. However, it's important to note that the specific findings and conclusions derived from the comparative analysis using COMSOL software may vary based on the input parameters, modeling assumptions, and simulation techniques employed. Experimental validation of the simulation results is essential to verify the accuracy and reliability of the conclusions.

ACKNOWLEDGMENT

We take this opportunity to express our deepest sense of gratitude and sincere thanks to everyone who helped us to complete this work successfully. We express our sincere thanks to Dr. Soni Kuriakose, Head of the Department, Mechanical Engineering, Mar Athanasius College of Engineering, Kothamangalam for providing us with all the necessary facilities and support. We would also like to express our sincere gratitude to our Project Coordinator and our project guide Dr. Arun Boby, Professor of Mechanical Engineering, at Mar Athanasius College of Engineering, Kothamangalam for their support and cooperation for the guidance and mentorship throughout the course. We are deeply indebted to Dr. Bos Mathew Jos, Principal of Mar Athanasius College of Engineering, Kothamangalam, for his encouragement and support. Finally, thank our family, and friends who contributed to the successful fulfillment of this project work.
REFERENCES


[2] Feipeng Wang, Tao Zhang, Jian Li, Khan Muhammad Zeeshan, Li He, Zhengy ong Huang and Yushuang He, 2018. DC Breakdown and Flashover Characteristics of Direct Fluorinated Epoxy/Al2O3 Nanocomposites, IEEE Transactions on Dielectrics and Electrical Insulation.

